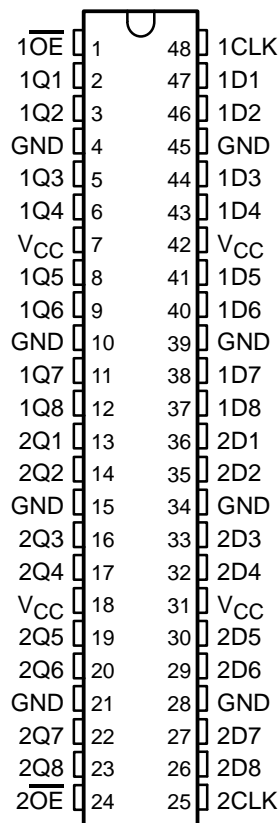


SN54ABT16374, SN74ABT16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Packaged in Plastic 300-mil Shrink Small-Outline Packages (DL) and 380-mil Fine-Pitch Ceramic Flat Packages (WD) Using 25-mil Center-to-Center Spacings

SN54ABT16374 . . . WD PACKAGE
SN74ABT16374 . . . DL PACKAGE
(TOP VIEW)



description

The 'ABT16374 is a 16-bit edge-triggered D-type flip-flop with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output enable (\overline{OE}) does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16374 is packaged in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT16374 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT16374 is characterized for operation from -40°C to 85°C .

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SN54ABT16374, SN74ABT16374

16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS

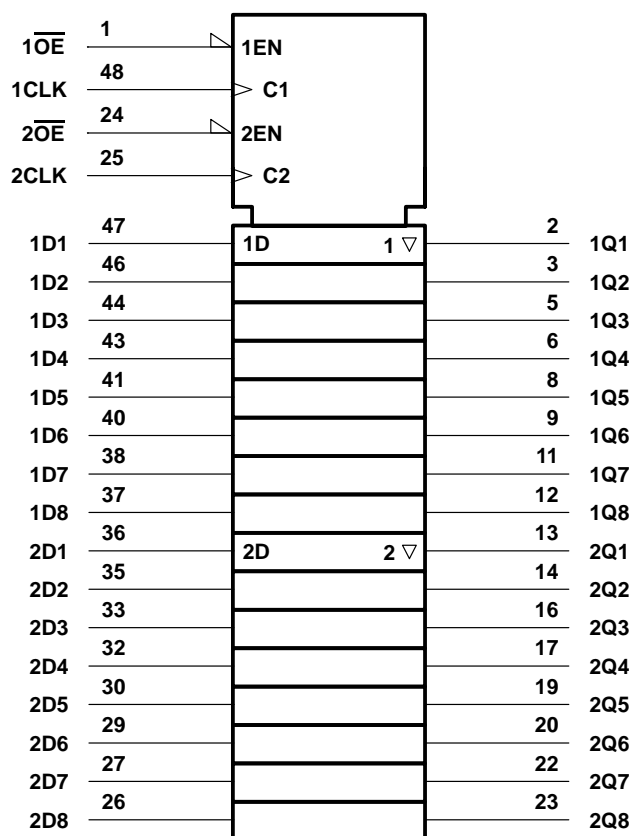
WITH 3-STATE OUTPUTS

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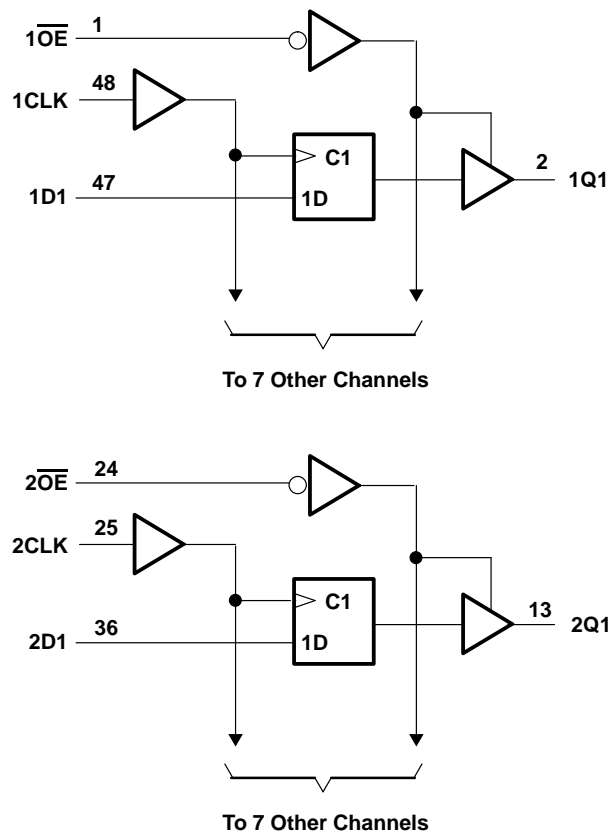
FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUT Q
OE	CLK	D	
L	↑	H	H
L	↑	L	L
L	H or L	X	Q ₀
H	X	X	Z

logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	-0.5 V to 5.5 V
Current into any output in the low state, I_O : SN54ABT16374	96 mA
SN74ABT16374	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	-18 mA
Output clamp current, I_{OK} ($V_O < 0$)	-50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air)	0.85 W
Storage temperature range	-65°C to 150°C

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

			SN54ABT16374		SN74ABT16374		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V _{IH}	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
V _I	Input voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current			−24		−32	mA
I _{OL}	Low-level output current			48		64	mA
Δt/Δv	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T _A	Operating free-air temperature		−55	125	−40	85	°C

NOTE 2: Unused or floating inputs must be held high or low.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A = 25°C			SN54ABT16374		SN74ABT16374		UNIT
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V _{IK}	V _{CC} = 4.5 V, I _I = −18 mA		−1.2			−1.2		−1.2		V
V _{OH}	V _{CC} = 4.5 V, I _{OH} = −3 mA		2.5			2.5		2.5		V
	V _{CC} = 5 V, I _{OH} = −3 mA		3			3		3		
	V _{CC} = 4.5 V, I _{OH} = −24 mA		2			2				
	V _{CC} = 4.5 V, I _{OH} = −32 mA		2‡					2		
V _{OL}	V _{CC} = 4.5 V, I _{OL} = 48 mA		0.55			0.55				V
	V _{CC} = 4.5 V, I _{OL} = 64 mA		0.55‡					0.55		
I _I	V _{CC} = 5.5 V, V _I = V _{CC} or GND		±1			±1		±1		μA
I _{OZH}	V _{CC} = 5.5 V, V _O = 2.7 V		50			50		50		μA
I _{OZL}	V _{CC} = 5.5 V, V _O = 0.5 V		−50			−50		−50		μA
I _{OFF}	V _{CC} = 0, V _I or V _O ≤ 4.5 V		±100					±100		μA
I _{CEX}	V _{CC} = 5.5 V, V _O = 5.5 V				50	50		50		μA
I _O §	V _{CC} = 5.5 V, V _O = 2.5 V		−50	−100	−180	−50	−180	−50	−180	mA
I _{CC}	V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND		Outputs high		2	2		2		mA
			Outputs low		67	67		67		
			Outputs disabled		2	2		2		
ΔI _{CC}	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND		1.5			1.5		1.5		mA
C _i	V _I = 2.5 V or 0.5 V		3.5							pF
C _O	V _O = 2.5 V or 0.5 V		9.5							pF

† All typical values are at $V_{CC} = 5\text{ V}$.

‡ On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$		SN54ABT16374		SN74ABT16374		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency	0	150	0	150	0	150	MHz
t_w	Pulse duration, CLK high or low	3.3		3.3		3.3		ns
t_{su}	Setup time, data before CLK↑	1.1		1.1		1.1		ns
t_h	Hold time, data after CLK↑	1.3		1.3		1.3		ns

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ$ C			SN54ABT16374		SN74ABT16374		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			150			150		150		MHz
t_{PLH}	CLK	Q	1.8	4.3	5.4	1.8	6.4	1.8	6.2	ns
t_{PHL}			2.7	4.5	5.6	2.7	6.4	2.7	5.9	
t_{PZH}	\overline{OE}	Q	1.4	3.6	4.8	1.4	6.1	1.4	5.7	ns
t_{PZL}			1.7	3.5	4.6	1.7	5.5	1.7	5.3	
t_{PHZ}	\overline{OE}	Q	2.2	5.4	8.4	2.2	11	2.2	10	ns
t_{PLZ}			2.3	4.6	7.7	2.3	9.8	2.3	8.7	

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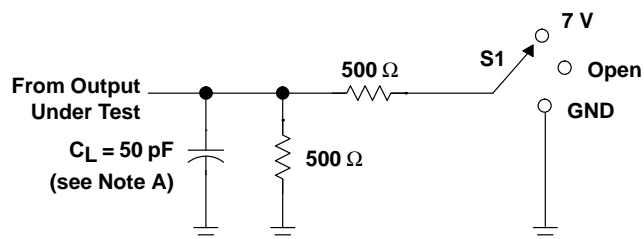
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WITH 3-STATE OUTPUTS

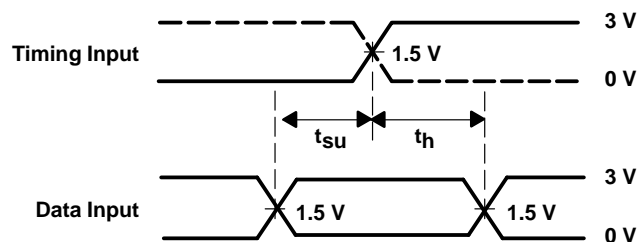
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PARAMETER MEASUREMENT INFORMATION

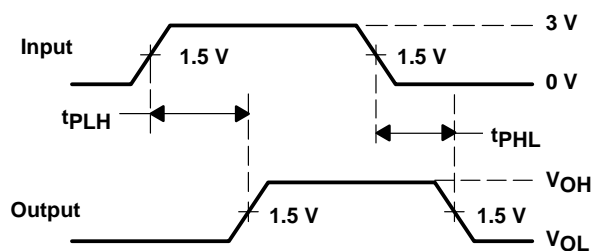


LOAD CIRCUIT FOR OUTPUTS

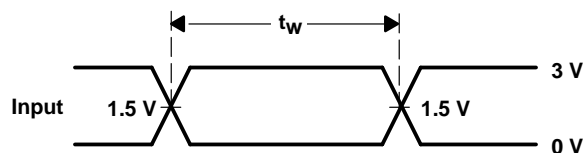
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



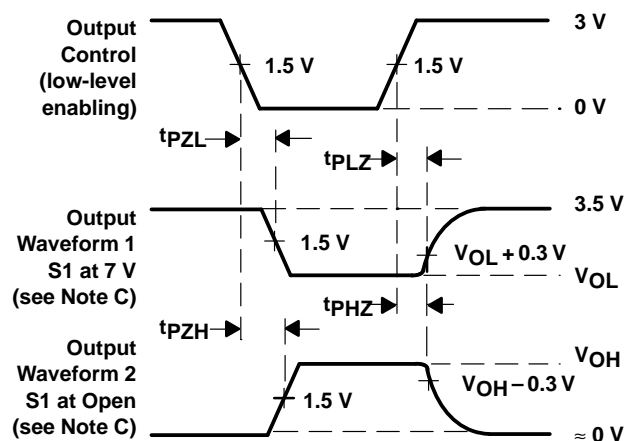
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_0 = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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